

更改 REV	变更内容 MODIFICATION	日期 DATE	制图 DRAW	审核 APPROVE
A	版面发行	2012/10/29	JDL	Oscar

NOTES:

MATERIAL:

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(U194V-0)
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE  $\phi 0.46\text{mm}$  (C5100).
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD COPPER ALLOY(OR STEEL ALLOY) 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

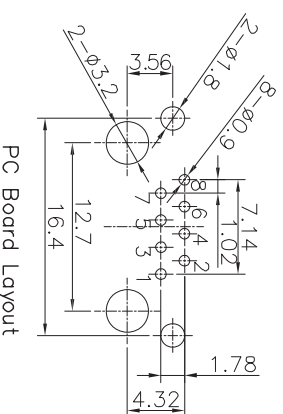
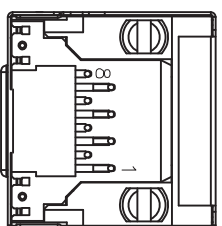
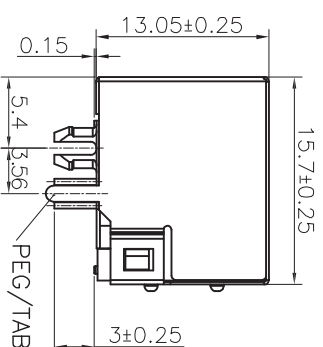
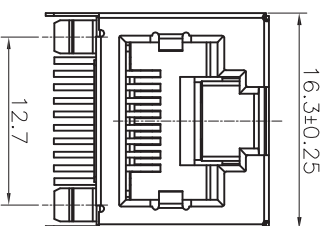
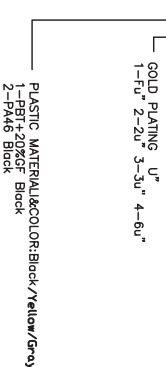
MECHANICAL:

- 1.DURRABILITY:750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER

ENVIRONMENTAL:

- 1.STORAGE :--40°C TO +85°C.
  2. OPERATION: -20°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.

PART NUMBER: 56A-S1188L0-XX



: Inspection Item		: Cp/Cpk and SPC Control Item	
DIMENSION IN mm [Inch]			
TOLERANCE UNLESS OTHERWISE SPECIFIED		X. ± 1"	
.X ± 0.20		.X ± 0.5"	
.XXX ± 0.15			
.XXXX ± 0.075			
批准 APPROVE	检查 CHECK	制图 DRAW	审核 SCALE
Oscar		1:1	A3
Shenzhen Chuangqin Technology Co., Ltd.		图号 DWG NO.	1
深圳市创勤科技有限公司		56A-S1188L0	1
56A 1X1 8P8C PCB JACK WITH SHIELDED SIDE ENTRY,TAB-UP,ROUND PIN		图号 DWG NO.	1
		1:1	A



A

B

C

D

E

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